

General Description

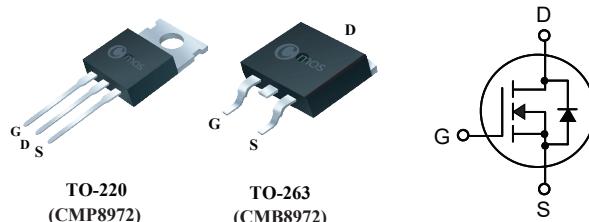
The 8972 is N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

Product Summary

BVDSS	RDSON	ID
20V	3.5mΩ	80A

Applications

- DC/DC converter
- Motor drives
- Power Management in Note book

TO-220/263 Pin Configuration**Features**

- Simple Drive Requirement
- Reliable and Rugged
- Low On-Resistance

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 8	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current	80	A
I_{DM}	Pulsed Drain Current ¹	320	A
EAS	Single Pulse Avalanche Energy ²	64.8	mJ
P_D	Total Power Dissipation	100	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient	---	2.5	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	20	---	---	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=4.5\text{V}$, $I_D=20\text{A}$	---	2.8	3.5	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}$, $I_D=20\text{A}$	---	3.2	4.5	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	0.5	---	1.5	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=16\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	uA
		$V_{\text{DS}}=16\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_C=85^\circ\text{C}$	---	---	30	
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 8\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_D=15\text{A}$	---	35	---	S
R_g	Gate Resistance	$V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	4	---	Ω
Q_g	Total Gate Charge	$I_D=50\text{A}$	---	32	---	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=10\text{V}$	---	15	---	
Q_{gd}	Gate-Drain Charge	$V_{\text{GS}}=4.5\text{V}$	---	7	---	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}}=10\text{V}$	---	20	---	ns
T_r	Rise Time	$I_D=50\text{A}$	---	15	---	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time	$R_G=1\Omega$	---	45	---	
T_f	Fall Time	$V_{\text{GEN}}=10\text{V}$	---	12	---	
C_{iss}	Input Capacitance		---	7200	---	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	800	---	
C_{rss}	Reverse Transfer Capacitance		---	650	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	80	A
I_{SM}	Pulsed Source Current ¹		---	---	320	A
V_{SD}	Diode Forward Voltage ¹	$V_{\text{GS}}=0\text{V}$, $I_{\text{SD}}=20\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.1	V

Note :

1.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$ 2.The test condition is $V_{\text{DD}}=10\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=36\text{A}$

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Typical Characteristics

